

FEATURES

- **Bidirectional Buffer for SDA and SCL Lines Increases Fanout**
- **Prevents SDA and SCL Corruption During Live Board Insertion and Removal from Backplane**
- Isolates Input SDA and SCL Lines from Output
- Compatible with I²C™, I²C Fast Mode and SMBus Standards (Up to 400kHz Operation)
- Small MSOP 8-Pin Package
- Low I_{CC} Chip Disable: <1μA (LTC4300A-1)
- READY Open Drain Output (LTC4300A-1)
- 1V Precharge on all SDA and SCL Lines
- Supports Clock Stretching, Arbitration and Synchronization
- 5V to 3.3V Level Translation (LTC4300A-2)
- High Impedance SDA, SCL Pins for V_{CC} = 0V

APPLICATIONS

- Hot Board Insertion
- Servers
- Capacitance Buffer/Bus Extender
- Desktop Computer

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 I²C is a trademark of Philips Electronics N. V.
 *U.S. Patent No. 6,650,174

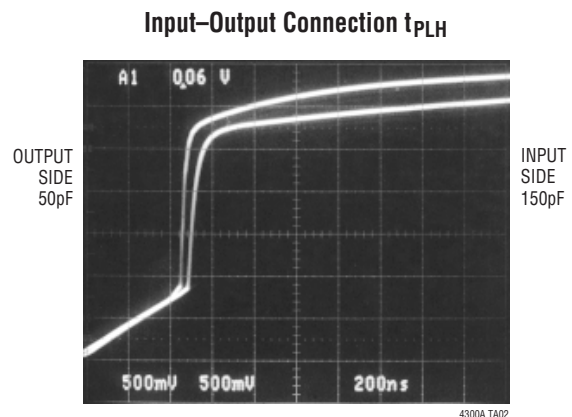
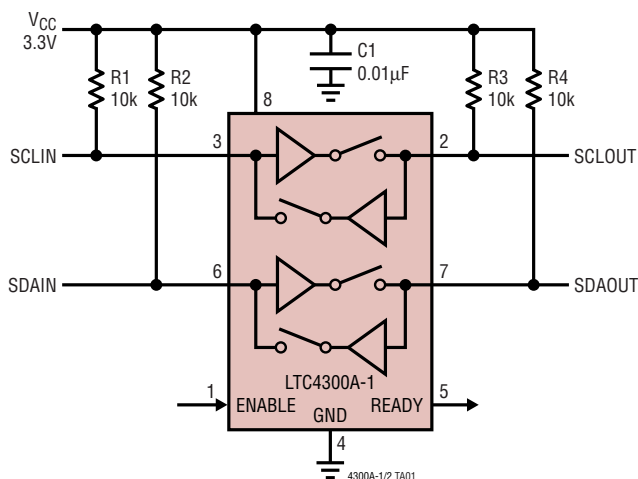
DESCRIPTION

The LTC®4300A series hot swappable 2-wire bus buffers allow I/O card insertion into a live backplane without corruption of the data and clock busses. When the connection is made, the LTC4300A-1/LTC4300A-2 provide bidirectional buffering, keeping the backplane and card capacitances isolated. Rise-time accelerator circuitry* allows the use of weaker DC pull-up currents while still meeting rise-time requirements. During insertion, the SDA and SCL lines are precharged to 1V to minimize bus disturbances.

The LTC4300A-1 incorporates a CMOS threshold digital ENABLE input pin, which forces the part into a low current mode when driven to ground and sets normal operation when driven to V_{CC}. It also includes an open drain READY output pin, which indicates that the backplane and card sides are connected together. The LTC4300A-2 replaces the ENABLE pin with a dedicated supply voltage pin, V_{CC2}, for the card side, providing level shifting between 3.3V and 5V systems. Both the backplane and card may be powered with supply voltages ranging from 2.7V to 5.5V, with no constraints on which supply voltage is higher. The LTC4300A-2 also replaces the READY pin with a digital CMOS input pin, ACC, which enables and disables the rise-time accelerator currents.

The LTC4300A is available in a small 8-pin MSOP package.

TYPICAL APPLICATION



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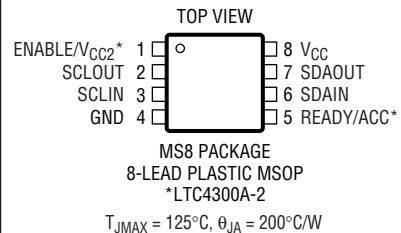
LTC4300A-1/LTC4300A-2

ABSOLUTE MAXIMUM RATINGS

(Note 1)

V_{CC} to GND	-0.3 to 7V
V_{CC2} to GND (LTC4300A-2)	-0.3 to 7V
SDAIN, SCLIN, SDAOUT, SCLOUT	-0.3 to 7V
READY, ENABLE (LTC4300A-1)	-0.3 to 7V
ACC (LTC4300A-2)	-0.3 to 7V
Operating Temperature Range	
LTC4300A-1C/LTC4300A-2C	0°C to 70°C
LTC4300A-1I/LTC4300A-2I	-40°C to 85°C
Storage Temperature Range	-65°C to 125°C
Lead Temperature (Soldering, 10 sec)	300°C

PACKAGE/ORDER INFORMATION

	ORDER PART NUMBER
	LTC4300A-1CMS8 LTC4300A-1IMS8 LTC4300A-2CMS8 LTC4300A-2IMS8
	MS8 PART MARKING
	LTABF LTABG LTACF LTACG

Consult LTC marketing for parts specified with wider operating temperature ranges.

ELECTRICAL CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25^\circ\text{C}$. $V_{CC} = 2.7\text{V}$ to 5.5V , unless otherwise noted.

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
Power Supply						
V_{CC}	Positive Supply Voltage		● 2.7		5.5	V
I_{CC}	Supply Current	$V_{CC} = 5.5\text{V}$, $V_{SDAIN} = V_{SCLIN} = 0\text{V}$, LTC4300A-1	●	5.1	7	mA
I_{SD}	Supply Current in Shutdown Mode	$V_{ENABLE} = 0\text{V}$, LTC4300A-1		0.1		μA
V_{CC2}	Card Side Supply Voltage	LTC4300A-2	● 2.7		5.5	V
I_{VCC1}	V_{CC} Supply Current	$V_{SDAIN} = V_{SCLIN} = 0\text{V}$, $V_{CC1} = V_{CC2} = 5.5\text{V}$, LTC4300A-2		3	4.1	mA
I_{VCC2}	V_{CC2} Supply Current	$V_{SDAOUT} = V_{SCLOUT} = 0\text{V}$, $V_{CC1} = V_{CC2} = 5.5\text{V}$, LTC4300A-2		2.1	2.9	mA
Start-Up Circuitry						
V_{PRE}	Precharge Voltage	SDA, SCL Floating	● 0.8	1.0	1.2	V
t_{IDLE}	Bus Idle Time		● 50	95	150	μs
V_{EN}	ENABLE Threshold Voltage	LTC4300A-1		$0.5 \cdot V_{CC}$	$0.9 \cdot V_{CC}$	V
V_{DIS}	Disable Threshold Voltage	LTC4300A-1, ENABLE Pin	$0.1 \cdot V_{CC}$	$0.5 \cdot V_{CC}$		V
I_{EN}	ENABLE Input Current	ENABLE from 0V to V_{CC} , LTC4300A-1		± 0.1	± 1	μA
t_{PHL}	ENABLE Delay, On-Off	LTC4300A-1		10		ns
	READY Delay, Off-On	LTC4300A-1		10		ns
t_{PLH}	ENABLE Delay, Off-On	LTC4300A-1		95		μs
	READY Delay, On-Off	LTC4300A-1		10		ns
I_{OFF}	READY OFF State Leakage Current	LTC4300A-1		± 0.1		μA
V_{OL}	READY Output Low Voltage	$I_{PULLUP} = 3\text{mA}$, LTC4300A-1	●		0.4	V

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ELECTRICAL CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25^\circ\text{C}$. $V_{CC} = 2.7\text{V}$ to 5.5V , unless otherwise noted.

SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
Rise-Time Accelerators							
I _{PULLUPAC}	Transient Boosted Pull-Up Current	Positive Transition on SDA,SCL, V _{CC} = 2.7V, Slew Rate = 1.25V/μs (Note 2), LTC4300A-2, ACC = 0.7 • V _{CC2} , V _{CC2} = 2.7V		1	2		mA
V _{ACCDIS}	Accelerator Disable Threshold	LTC4300A-2		0.3 • V _{CC2}	0.5 • V _{CC2}		V
V _{ACCEN}	Accelerator Enable Threshold	LTC4300A-2			0.5 • V _{CC2}	0.7 • V _{CC2}	V
I _{VACC}	ACC Input Current	LTC4300A-2			±0.1	±1	μA
t _{PDOFF}	ACC Delay, On/Off	LTC4300A-2			5		ns
Input-Output Connection							
V _{OS}	Input-Output Offset Voltage	10k to V _{CC} on SDA, SCL, V _{CC} = 3.3V (Note 3), LTC4300A-2, V _{CC2} = 3.3V, V _{IN} = 0.2V	●	0	100	175	mV
f _{SCL, SDA}	Operating Frequency	Guaranteed by Design, Not Subject to Test		0		400	kHz
C _{IN}	Digital Input Capacitance	Guaranteed by Design, Not Subject to Test				10	pF
V _{OL}	Output Low Voltage, Input = 0V	SDA, SCL Pins, I _{SINK} = 3mA, V _{CC} = 2.7V, V _{CC2} = 2.7V, LTC4300A-2	●	0		0.4	V
I _{LEAK}	Input Leakage Current	SDA, SCL Pins = V _{CC} = 5.5V, LTC4300A-2, V _{CC2} = 5.5V				±5	μA
Timing Characteristics							
f _{I2C}	I ² C Operating Frequency	(Note 4)		0		400	kHz
t _{BUF}	Bus Free Time Between Stop and Start Condition	(Note 4)		1.3			μs
t _{hD,STA}	Hold Time After (Repeated) Start Condition	(Note 4)		0.6			μs
t _{su,STA}	Repeated Start Condition Setup Time	(Note 4)		0.6			μs
t _{su,STO}	Stop Condition Setup Time	(Note 4)		0.6			μs
t _{hD, DAT}	Data Hold Time	(Note 4)		300			ns
t _{su, DAT}	Data Setup Time	(Note 4)		100			ns
t _{LOW}	Clock Low Period	(Note 4)		1.3			μs
t _{HIGH}	Clock High Period	(Note 4)		0.6			μs
t _f	Clock, Data Fall Time	(Notes 4, 5)		20 + 0.1 • C _B		300	ns
t _r	Clock, Data Rise Time	(Notes 4, 5)		20 + 0.1 • C _B		300	ns

Note 1: Absolute Maximum Ratings are those values beyond which the life of a device may be impaired

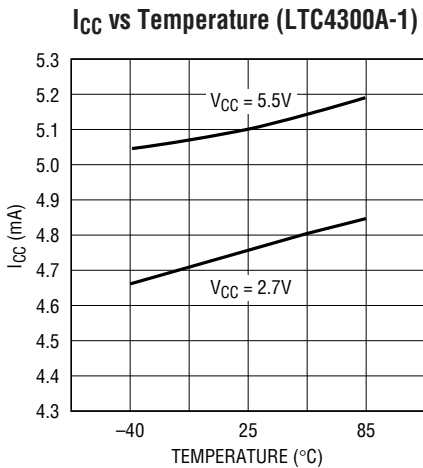
Note 2: $I_{PULLUPAC}$ varies with temperature and V_{CC} voltage, as shown in the Typical Performance Characteristics section.

Note 3: The connection circuitry always regulates its output to a higher voltage than its input. The magnitude of this offset voltage as a function of the pullup resistor and V_{CC} voltage is shown in the Typical Performance Characteristics section.

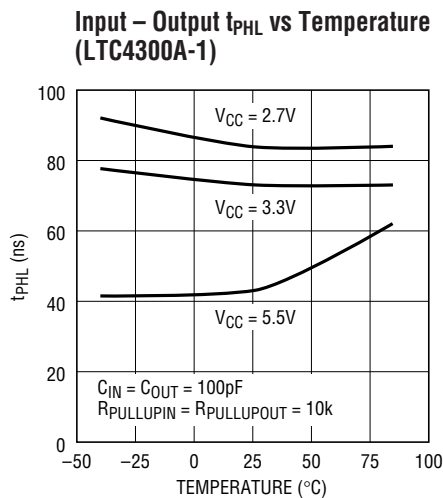
Note 4: Guaranteed by design, not subject to test.

Note 5: C_B = total capacitance of one bus line in pF.

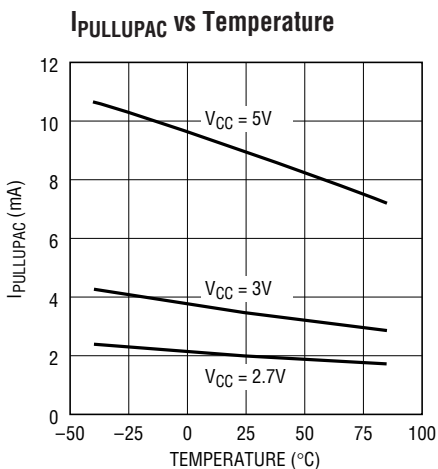
TYPICAL PERFORMANCE CHARACTERISTICS



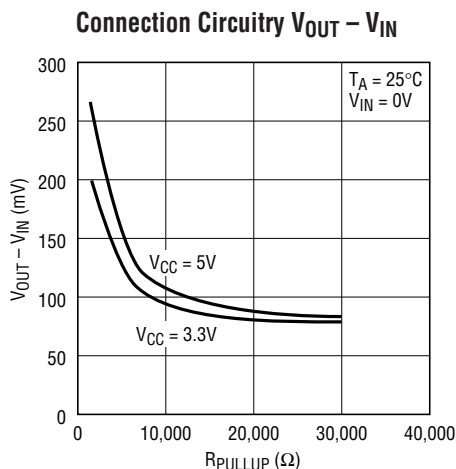
4300-1/2 G01



4300-1/2 G02



4300-1/2 G03



4300-1/2 G04

PIN FUNCTIONS

ENABLE/V_{CC2} (Pin 1): Chip Enable Pin/Card Supply Voltage. For the LTC4300A-1, this is a digital CMOS threshold input pin. Grounding this pin puts the part in a low current (<1 μ A) mode. It also disables the rise-time accelerators, disables the bus precharge circuitry, drives READY low, isolates SDAIN from SDAOUT and isolates SCLIN from SCLOUT. Drive ENABLE all the way to V_{CC} for normal operation. Connect ENABLE to V_{CC} if this feature is not being used. For the LTC4300A-2, this is the supply voltage for the devices on the card I²C busses. Connect pull-up resistors from SDAOUT and SCLOUT to this pin. Place a bypass capacitor of at least 0.01 μ F close to this pin for best results.

SCLOUT (Pin 2): Serial Clock Output. Connect this pin to the SCL bus on the card.

SCLIN (Pin 3): Serial Clock Input. Connect this pin to the SCL bus on the backplane.

GND (Pin 4): Ground. Connect this pin to a ground plane for best results.

READY/ACC (Pin 5): Connection Flag/Rise-Time Accelerator Control. For the LTC4300A-1, this is an open-drain NMOS output which pulls low when either ENABLE is low or the start-up sequence described in the Operation section has not been completed. READY goes high when ENABLE is high and start-up is complete. Connect a 10k resistor from this pin to V_{CC} to provide the pull up. For the LTC4300A-2, this is a CMOS threshold digital input pin that enables and disables the rise-time accelerators on all four SDA and SCL pins. Drive ACC all the way to the V_{CC2} supply voltage to enable all four accelerators; drive ACC to ground to turn them off.

SDAIN (Pin 6): Serial Data Input. Connect this pin to the SDA bus on the backplane.

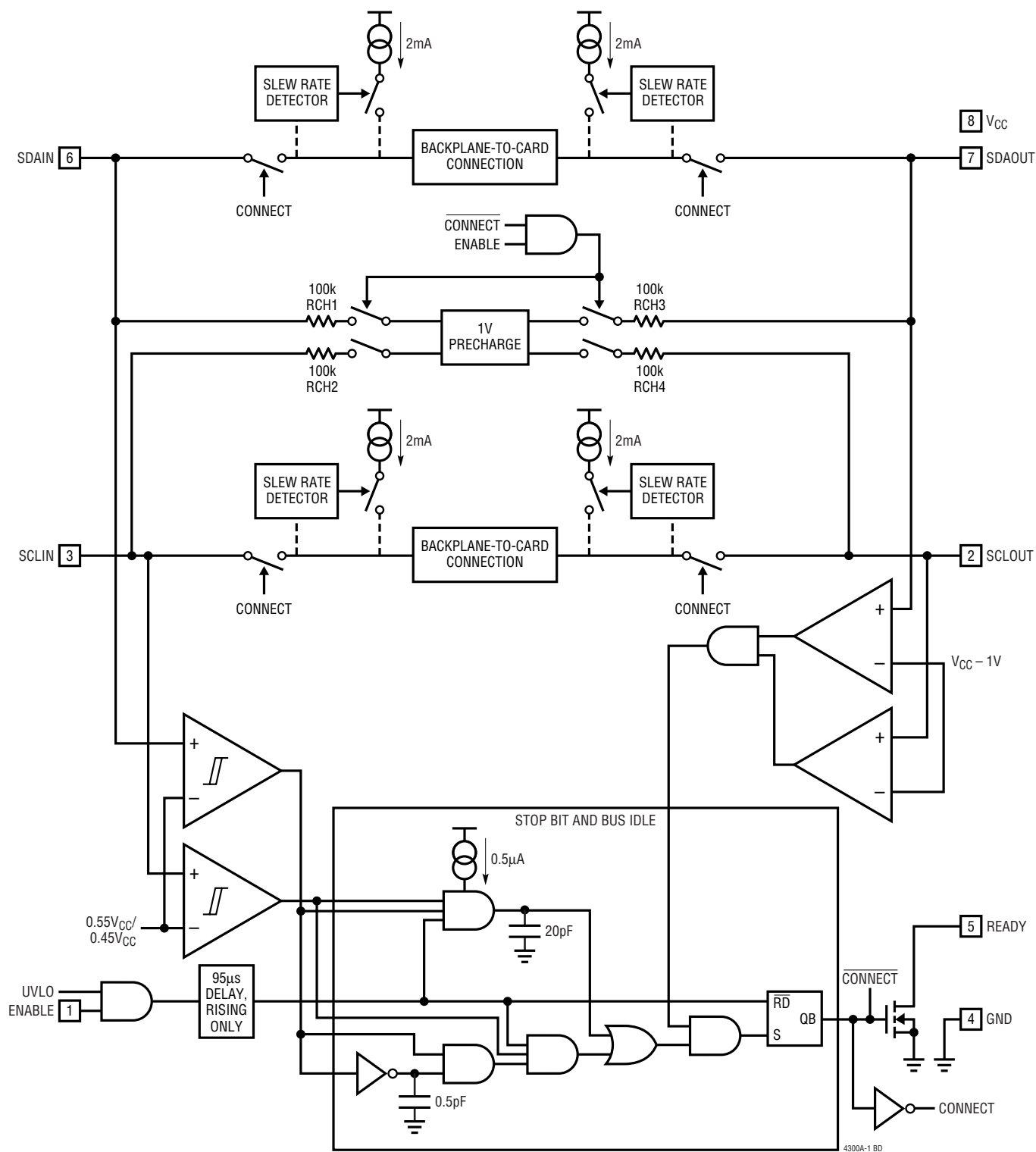
SDAOUT (Pin 7): Serial Data Output. Connect this pin to the SDA bus on the card.

V_{CC} (Pin 8): Main Input Power Supply from Backplane. This is the supply voltage for the devices on the backplane I²C busses. Connect pull-up resistors from SDAIN and SCLIN (and also from SDAOUT and SCLOUT for the LTC4300A-1) to this pin. Place a bypass capacitor of at least 0.01 μ F close to this pin for best results.

LTC4300A-1/LTC4300A-2

BLOCK DIAGRAM (LTC4300A-1)

2-Wire Bus Buffer and Hot Swap™ Controller

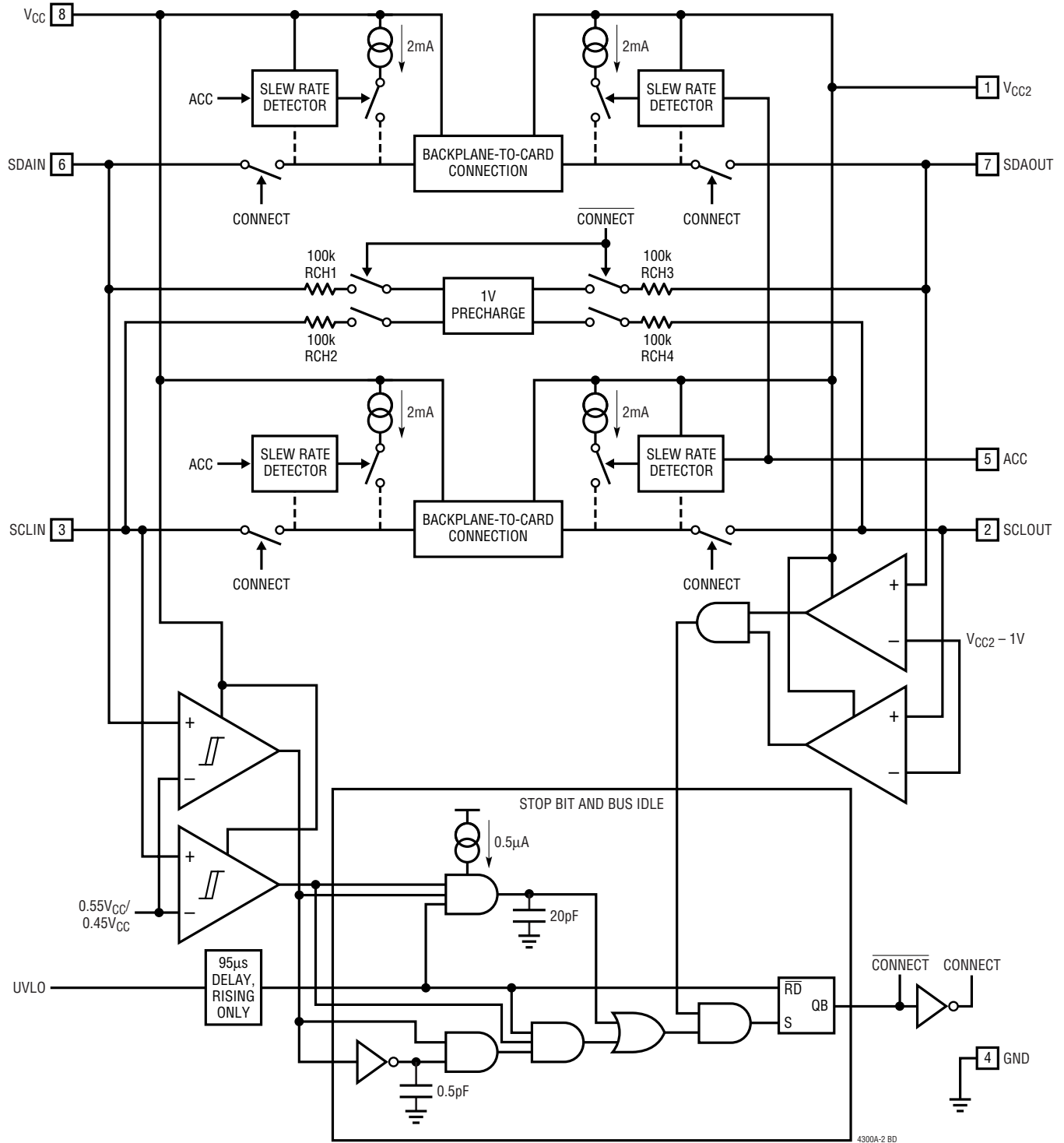


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BLOCK DIAGRAM (LTC4300A-2)

2-Wire Bus Buffer and Hot Swap Controller



OPERATION

Start-Up

When the LTC4300A first receives power on its V_{CC} pin, either during power-up or during live insertion, it starts in an undervoltage lockout (UVLO) state, ignoring any activity on the SDA and SCL pins until V_{CC} rises above 2.5V. For the LTC4300A-2, the part also waits for V_{CC2} to rise above 2V. This ensures that the part does not try to function until it has enough voltage to do so.

During this time, the 1V precharge circuitry is also active and forces 1V through 100k nominal resistors to the SDA and SCL pins. Because the I/O card is being plugged into a live backplane, the voltage on the backplane SDA and SCL busses may be anywhere between 0V and V_{CC} . Precharging the SCL and SDA pins to 1V minimizes the worst-case voltage differential these pins will see at the moment of connection, therefore minimizing the amount of disturbance caused by the I/O card.

Once the LTC4300A comes out of UVLO, it assumes that SDAIN and SCLIN have been inserted into a live system and that SDAOUT and SCLOUT are being powered up at the same time as itself. Therefore, it looks for either a stop bit or bus idle condition on the backplane side to indicate the completion of a data transaction. When either one occurs, the part also verifies that both the SDAOUT and SCLOUT voltages are high. When all of these conditions are met, the input-to-output connection circuitry is activated, joining the SDA and SCL busses on the I/O card with those on the backplane, and the rise time accelerators are enabled.

Connection Circuitry

Once the connection circuitry is activated, the functionality of the SDAIN and SDAOUT pins is identical. A low forced on either pin at any time results in both pin voltages being low. For proper operation, logic low input voltages should be no higher than 0.4V with respect to the ground pin voltage of the LTC4300A. SDAIN and SDAOUT enter a logic high state only when all devices on both SDAIN and SDAOUT release high. The same is true for SCLIN and SCLOUT. This important feature ensures that clock stretching, clock synchronization, arbitration and the acknowledge protocol always work, regardless of how the devices in the system are tied to the LTC4300A.

Another key feature of the connection circuitry is that it provides bidirectional buffering, keeping the backplane and card capacitances isolated. Because of this isolation, the waveforms on the backplane busses look slightly different than the corresponding card bus waveforms, as described here.

Input to Output Offset Voltage

When a logic low voltage, V_{LOW1} , is driven on any of the LTC4300A's data or clock pins, the LTC4300A regulates the voltage on the other side of the chip (call it V_{LOW2}) to a slightly higher voltage, as directed by the following equation:

$$V_{LOW2} = V_{LOW1} + 75\text{mV} + (V_{CC}/R) \cdot 100$$

where R is the bus pull-up resistance in ohms. For example, if a device is forcing SDAOUT to 10mV where $V_{CC} = 3.3\text{V}$ and the pull-up resistor R on SDAIN is 10k, then the voltage on SDAIN = $10\text{mV} + 75\text{mV} + (3.3/10000) \cdot 100 = 118\text{mV}$. See the Typical Performance Characteristics section for curves showing the offset voltage as a function of V_{CC} and R.

Propagation Delays

During a rising edge, the rise-time on each side is determined by the combined pull-up current of the LTC4300A boost current and the bus resistor and the equivalent capacitance on the line. If the pull-up currents are the same, a difference in rise-time occurs which is directly proportional to the difference in capacitance between the two sides. This effect is displayed in Figure 1 for $V_{CC} = 3.3\text{V}$ and a 10k pull-up resistor on each side (50pF on one side and 150pF on the other). Since the output side has less capacitance than the input, it rises faster and the effective t_{PLH} is negative.

There is a finite propagation delay, t_{PHL} , through the connection circuitry for falling waveforms. Figure 2 shows the falling edge waveforms for the same V_{CC} , pull-up resistors and equivalent capacitance conditions as used in Figure 1. An external NMOS device pulls down the voltage on the side with 150pF capacitance; the LTC4300A pulls down the voltage on the opposite side, with a delay of 55ns. This delay is always positive and is a function of

OPERATION

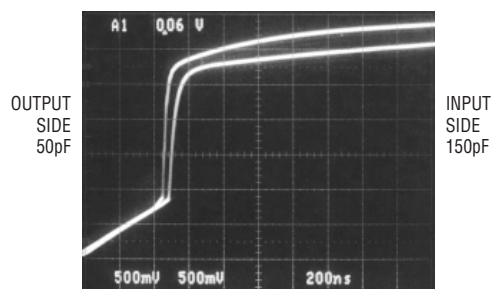


Figure 1. Input-Output Connection t_{PLH}

supply voltage, temperature and the pull-up resistors and equivalent bus capacitances on both sides of the bus. The Typical Performance Characteristics section shows t_{PLH} as a function of temperature and voltage for 10k pull-up resistors and 100pF equivalent capacitance on both sides of the part. By comparison with Figure 2, the $V_{CC} = 3.3V$ curve shows that increasing the capacitance from 50pF to 100pF results in a t_{PLH} increase from 55ns to 75ns. Larger output capacitances translate to longer delays (up to 150ns). Users must quantify the difference in propagation times for a rising edge versus a falling edge in their systems and adjust setup and hold times accordingly.

Rise-Time Accelerators

Once connection has been established, rise-time accelerator circuits on all four SDA and SCL pins are activated. These allow the user to choose weaker DC pull-up currents on the bus, reducing power consumption while still meeting system rise-time requirements. During positive bus transitions, the LTC4300A switches in 2mA (typical) of current to quickly slew the SDA and SCL lines once their DC voltages exceed 0.6V. Using a general rule of 20pF of capacitance for every device on the bus (10pF for the device and 10pF for interconnect), choose a pull-up current so that the bus will rise on its own at a rate of at least 1.25V/ μ s to guarantee activation of the accelerators.

For example, assume an SMBus system with $V_{CC} = 3V$, a 10k pull-up resistor and equivalent bus capacitance of 200pF. The rise-time of an SMBus system is calculated from $(V_{IL(MAX)} - 0.15V)$ to $(V_{IH(MIN)} + 0.15V)$, or 0.65V to 2.25V. It takes an RC circuit 0.92 time constants to traverse this voltage for a 3V supply; in this case, $0.92 \cdot (10k \cdot 200pF) = 1.84\mu s$. Thus, the system exceeds the maximum allowed rise-time of 1 μ s by 84%. However,

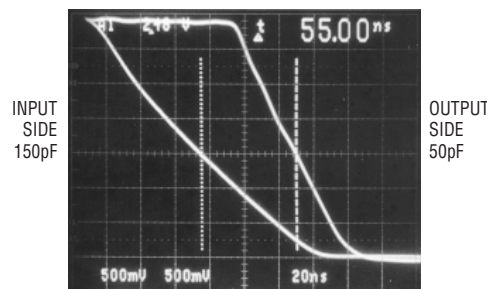


Figure 2. Input-Output Connection t_{PHL}

using the rise-time accelerators, which are activated at a DC threshold of below 0.65V, the worst-case rise-time is: $(2.25V - 0.65V) \cdot 200pF/1mA = 320ns$, which meets the 1 μ s rise-time requirement.

READY Digital Output (LTC4300A-1)

This pin provides a digital flag which is low when either ENABLE is low or the start-up sequence described earlier in this section has not been completed. READY goes high when ENABLE is high and start-up is complete. The pin is driven by an open drain pull-down capable of sinking 3mA while holding 0.4V on the pin. Connect a resistor of 10k to V_{CC} to provide the pull-up. This feature is available for the LTC4300A-1 only.

ENABLE Low Current Disable (LTC4300A-1)

Grounding the ENABLE pin disconnects the backplane side from the card side, disables the rise-time accelerators, drives READY low, disables the bus precharge circuitry and puts the part in a near-zero current state. When the pin voltage is driven all the way to V_{CC} , the part waits for data transactions on both the backplane and card sides to be complete (as described in the Start-Up section) before reconnecting the two sides. This feature is available for the LTC4300A-1 only.

ACC Boost Current Enable (LTC4300A-2)

Users having lightly loaded systems may wish to disable the rise-time accelerators. Driving this pin to ground turns off the rise-time accelerators on all four SDA and SCL pins. Driving this pin to the V_{CC2} voltage enables normal operation of the rise-time accelerators, as described in the Rise-Time Accelerators section above. This feature is available for the LTC4300A-2 only.

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APPLICATIONS INFORMATION

Resistor Pull-Up Value Selection

The system pull-up resistors must be strong enough to provide a positive slew rate of $1.25\text{V}/\mu\text{s}$ on the SDA and SCL pins, in order to activate the boost pull-up currents during rising edges. Choose maximum resistor value R using the formula:

$$R \leq (V_{CC(\text{MIN})} - 0.6) (800,000) / C$$

where R is the pull-up resistor value in ohms, $V_{CC(\text{MIN})}$ is the minimum V_{CC} voltage and C is the equivalent bus capacitance in picofarads (pF).

In addition, regardless of the bus capacitance, always choose $R \leq 16\text{k}$ for $V_{CC} = 5.5\text{V}$ maximum, $R \leq 24\text{k}$ for $V_{CC} = 3.6\text{V}$ maximum. The start-up circuitry requires logic high voltages on SDAOUT and SCLOUT to connect the backplane to the card, and these pull-up values are needed to overcome the precharge voltage.

Live Insertion and Capacitance Buffering Application

Figures 3 through 6 illustrate the usage of the LTC4300A in applications that take advantage of both its hot swap controlling and capacitance buffering features. In all of

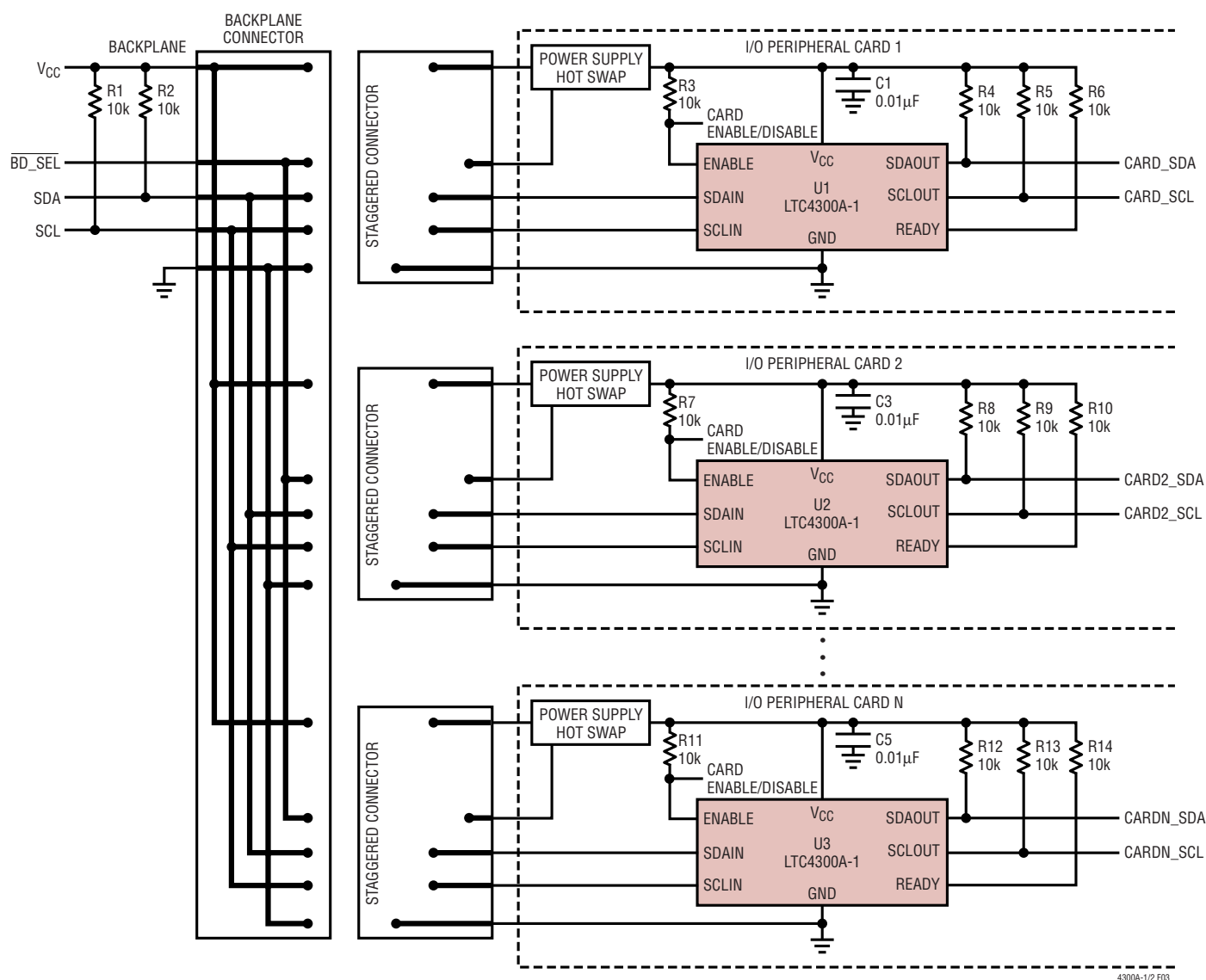


Figure 3. Inserting Multiple I/O Cards into a Live Backplane Using the LTC4300A-1 in a CompactPCI System

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APPLICATIONS INFORMATION

these applications, note that if the I/O cards were plugged directly into the backplane, all of the backplane and card capacitances would add directly together, making rise- and fall-time requirements difficult to meet. Placing a LTC4300A on the edge of each card, however, isolates the card capacitance from the backplane. For a given I/O card, the LTC4300A drives the capacitance of everything on the card and the backplane must drive only the capacitance of the LTC4300A, which is less than 10pF.

Figure 3 shows the LTC4300A-1 in a CompactPCI™ configuration. Connect V_{CC} and ENABLE to the output of one of the CompactPCI power supply Hot Swap circuits. Use a pull-up resistor to ENABLE for a card side enable/disable.

V_{CC} is monitored by a filtered UVLO circuit. With the V_{CC} voltage powering up after all other pins have established connection, the UVLO circuit ensures that the backplane and card data and clock busses are not connected until the transients associated with live insertion have settled. Owing to their small capacitance, the SDAIN and SCLIN pins cause minimal disturbance on the backplane busses when they make contact with the connector.

Figure 4 shows the LTC4300A-2 in a CompactPCI configuration. The LTC4300A-2 receives its V_{CC} voltage from one of the long “early power” pins. Because this power is not switched, add a 5 Ω to 10 Ω resistor between the V_{CC} pins

CompactPCI is a trademark of the PCI Industrial Computer Manufacturers Group.

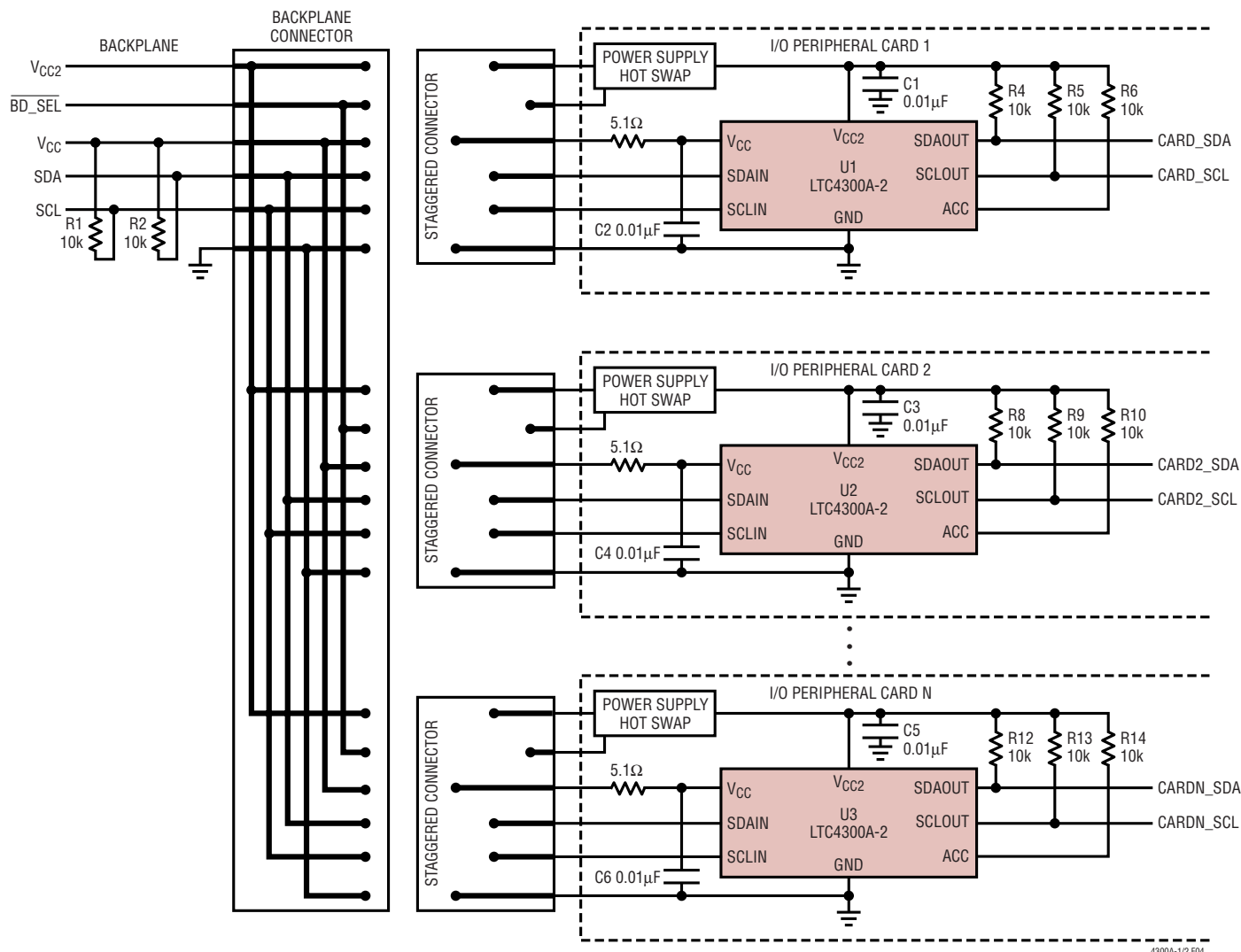


Figure 4. Inserting Multiple I/O Cards into a Live Backplane Using the LTC4300A-2 in a CompactPCI System

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APPLICATIONS INFORMATION

of the connector and the LTC4300A-2, as shown in the figure. In addition, make sure that the V_{CC} bypassing on the backplane is large compared to the $0.01\mu\text{F}$ bypass capacitor on the card. Establishing early power V_{CC} ensures that the 1V precharge voltage is present at the SDAIN and SCLIN pins before they make contact. Connect V_{CC2} to the output of one of the CompactPCI power supply Hot Swap circuits. V_{CC2} is monitored by a filtered UVLO circuit. With the V_{CC2} voltage powering up after all other pins have established connection, the UVLO circuit ensures that the backplane and card data and clock busses are not connected until the transients associated with live insertion have settled.

Figure 5 shows the LTC4300A-1 in a PCI application, where all of the pins have the same length. In this case, connect an RC series circuit on the I/O card between V_{CC} and ENABLE. An RC product of 10ms provides a filter to prevent the LTC4300A-1 from becoming activated until the transients associated with live insertion have settled.

Figure 6 shows the LTC4300A-2 in an application where the user has a custom connector with pins of three different lengths available. Making V_{CC2} the shortest pin ensures that all other pins are firmly connected before V_{CC2} receives any voltage. A filtered UVLO circuit on V_{CC2} ensures that the V_{CC2} pin is firmly connected before the LTC4300A-2 connects the backplane to the card.

Repeater/Bus Extender Application

Users who wish to connect two 2-wire systems separated by a distance can do so by connecting two LTC4300A-1s back-to-back, as shown in Figure 7. The I²C specification allows for 400pF maximum bus capacitance, severely limiting the length of the bus. The SMBus specification places no restriction on bus capacitance, but the limited impedances of devices connected to the bus require systems to remain small if rise- and fall-time specifications are to be met. The strong pull-up and pull-down impedances of the LTC4300A-1 are capable of

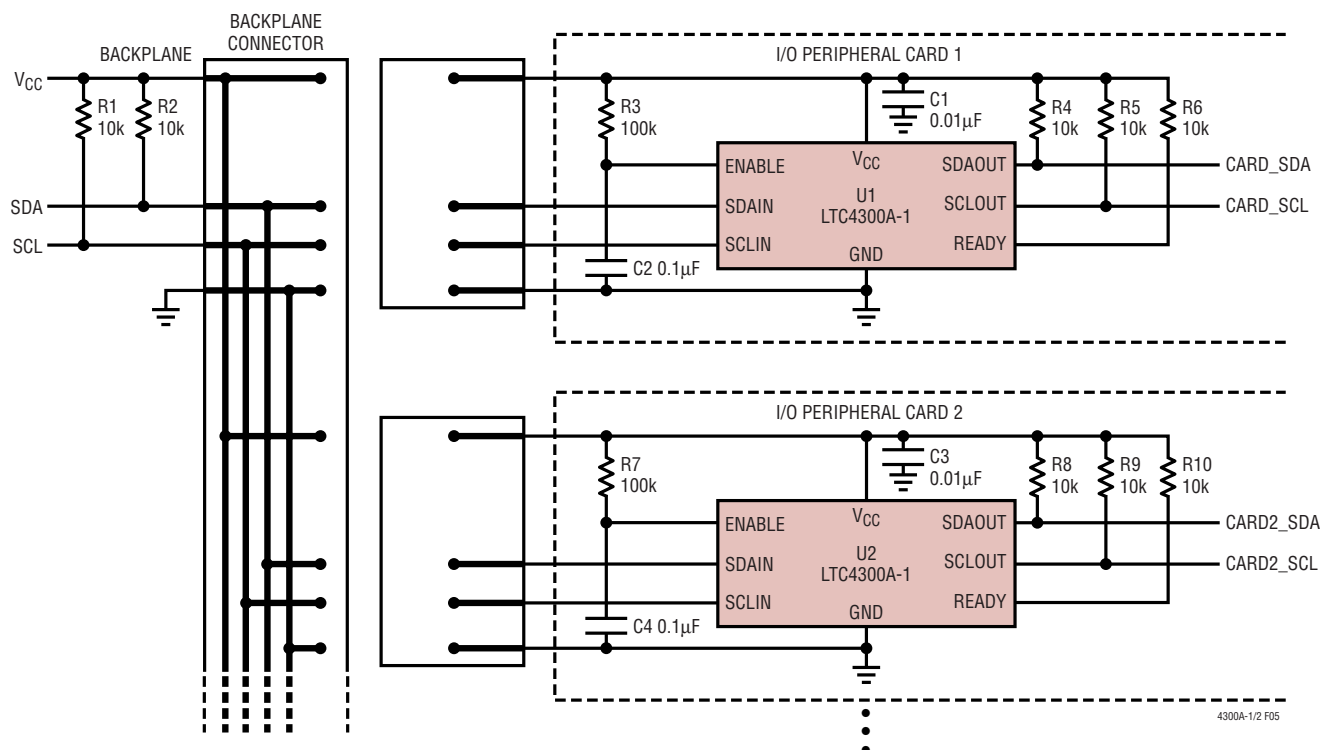


Figure 5. Inserting Multiple I/O Cards into a Live Backplane Using the LTC4300A-1 in a PCI System



APPLICATIONS INFORMATION

meeting rise- and fall-time specifications for one nanofarad of capacitance, thus allowing much more interconnect distance. In this situation, the differential ground voltage between the two systems may limit the allowed distance, because a valid logic low voltage with respect to the ground at one end of the system may violate the allowed V_{OL} specification with respect to the ground at the other end. In addition, the connection circuitry offset voltages of the back-to-back LTC4300A-1s add together, directly contributing to the same problem.

Systems with Disparate Supply Voltages (LTC4300A-1)

In large 2-wire systems, the V_{CC} voltages seen by devices at various points in the system can differ by a few hundred millivolts or more. This situation is well modelled by a series resistor in the V_{CC} line, as shown in Figure 8. For proper operation of the LTC4300A-1, make sure that $V_{CC(BUS)} \geq V_{CC(LTC4300A)} - 0.5V$.

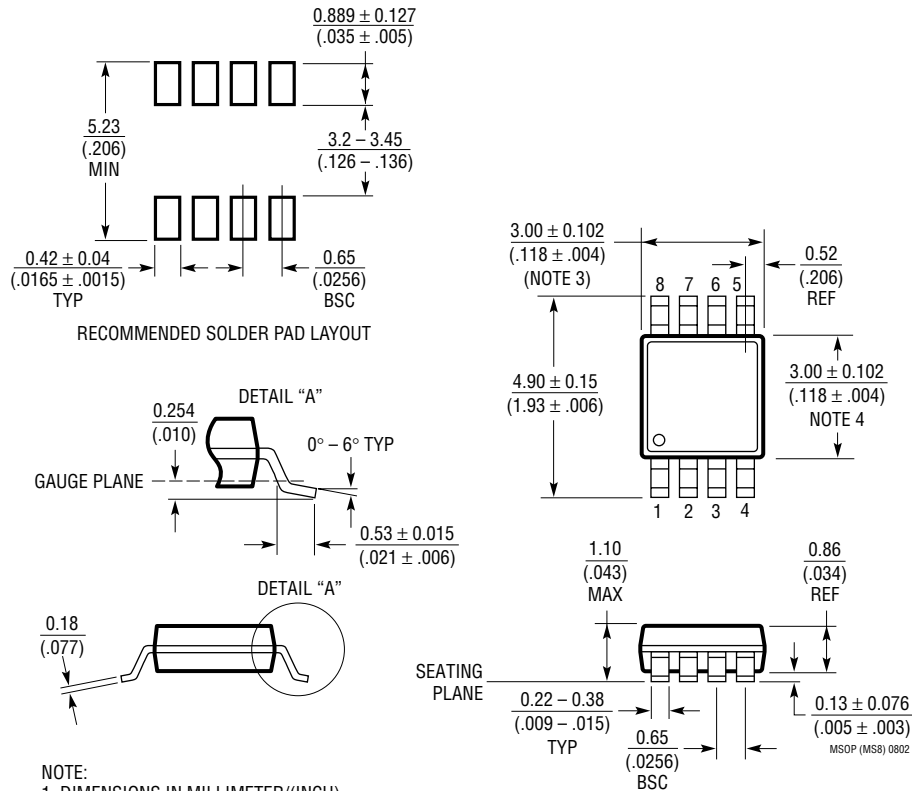
5V to 3.3V Level Translator and Power Supply Redundancy (LTC4300A-2)

Systems requiring different supply voltages for the backplane side and the card side can use the LTC4300A-2, as shown in Figure 9. The pull-up resistors on the card side connect from SDAOUT to SCLOUT to V_{CC2} , and those on the backplane side connect from SDAIN and SCLIN to V_{CC} . The LTC4300A-2 functions for voltages ranging from 2.7V to 5.5V on both V_{CC} and V_{CC2} . There is no constraint on the voltage magnitudes of V_{CC} and V_{CC2} with respect to each other.

This application also provides power supply redundancy. If the V_{CC2} voltage falls below its UVLO threshold, the LTC4300A-2 disconnects the backplane from the card, so that the backplane can continue to function. If the V_{CC} voltage falls below its UVLO threshold and the V_{CC2} voltage remains active, ground the ACC pin to ensure proper operation.

PACKAGE DESCRIPTION

MS8 Package
8-Lead Plastic MSOP
 (Reference LTC DWG # 05-08-1660)



NOTE:

1. DIMENSIONS IN MILLIMETER/(INCH)
2. DRAWING NOT TO SCALE
3. DIMENSION DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.
MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.152mm (.006") PER SIDE
4. DIMENSION DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSIONS.
INTERLEAD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.152mm (.006") PER SIDE
5. LEAD COPLANARITY (BOTTOM OF LEADS AFTER FORMING) SHALL BE 0.102mm (.004") MAX

TYPICAL APPLICATIONS

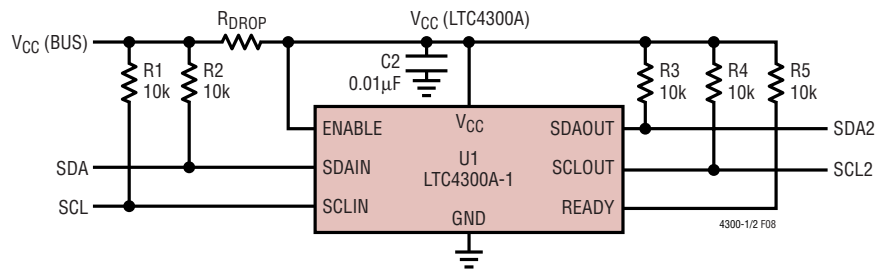


Figure 8. System with Disparate V_{CC} Voltages

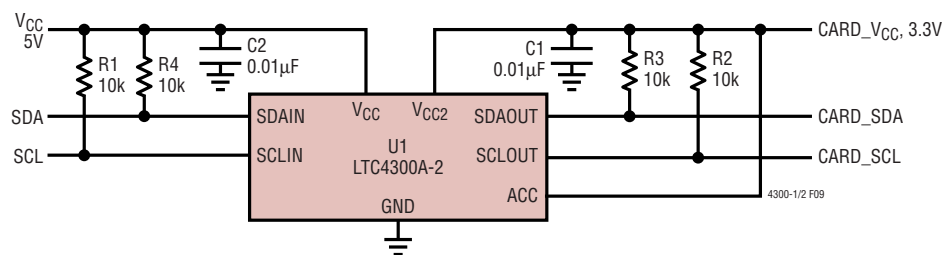


Figure 9. 5V to 3.3V Level Translator

RELATED PARTS

PART NUMBER	DESCRIPTION	COMMENTS
LTC1380/LTC1393	Single-Ended 8-Channel/Differential 4-Channel Analog Mux with SMBus Interface	Low R _{ON} : 35Ω Single-Ended/70Ω Differential, Expandable to 32 Single or 16 Differential Channels
LTC1427-50	Micropower, 10-Bit Current Output DAC with SMBus Interface	Precision 50µA ± 2.5% Tolerance Over Temperature, 4 Selectable SMBus Addresses, DAC Powers up at Zero or Midscale
LTC1623	Dual High Side Switch Controller with SMBus Interface	8 Selectable Addresses/16-Channel Capability
LTC1663	SMBus Interface 10-Bit Rail-to-Rail Micropower DAC	DNL < 0.75LSB Max, 5-Lead SOT-23 Package
LTC1694/LTC1694-1	SMBus Accelerator	Improved SMBus/I ² C Rise-Time, Ensures Data Integrity with Multiple SMBus/I ² C Devices
LT1786F	SMBus Controlled CCFL Switching Regulator	1.25A, 200kHz, Floating or Grounded Lamp Configurations
LTC1695	SMBus/I ² C Fan Speed Controller in ThinSOT™	0.75Ω PMOS 180mA Regulator, 6-Bit DAC
LTC1840	Dual I ² C Fan Speed Controller	Two 100µA 8-Bit DACs, Two Tach Inputs, Four GPIO

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